



NGW75T65H3DFP

650 V, 75 A trench field-stop IGBT with full rated silicon diode

Rev. 1 — 17 January 2025

Product data sheet

1. General description

The NGW75T65H3DFP is a robust Insulated-Gate Bipolar Transistor (IGBT) featuring third-generation technology. It combines carrier stored trench-gate and field-stop (FS) structures. The NGW75T65H3DFP is rated to 175 °C with optimized IGBT turn-off losses. This hard-switching 650 V, 75 A IGBT is optimized for high-voltage, high-frequency industrial power inverter applications.

2. Features

- Device current is rated at 75 A
- Low conduction and switching losses
- Stable and tight parameters for easy parallel operation
- Maximum junction temperature 175 °C
- Fully rated and fast reverse recovery diode
- HV-H3TRB qualified

3. Applications

- Power inverters such as
 - Uninterruptible Power Supply (UPS) inverter
 - EV charging converter
- Power Factor Correction (PFC)
- Induction heating
- Welding

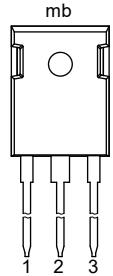
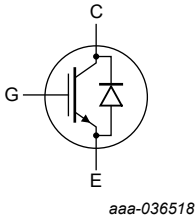
4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|--------------------------------|-------------------------|-----|-----|------|
| V_{CES} | collector-emitter voltage | $T_{vj} = 25\text{ °C}$ | - | 650 | V |
| T_{vj} | operating junction temperature | | -40 | 175 | °C |

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|---------------------------------------|---|---|
| 1 | G | gate |  |  |
| 2 | C | collector | | |
| 3 | E | emitter | | |
| mb | C | mounting base; connected to collector | | |

6. Ordering information

Table 3. Ordering information

| Type number | Package | | |
|-------------------------------|-----------|--|--------------------------|
| | Name | Description | Version |
| NGW75T65H3DFP | TO-247-3L | Plastic single-ended through-hole package; heatsink mounted; 1 mounting hole; 3-lead TO-247-3L | SOT429-2 |

7. Limiting values

Table 4. Limiting values

| Symbol | Parameter | Conditions | Min | Max | Unit |
|--------------|-----------------------------------|--------------------------|-----|-----|------|
| IGBT | | | | | |
| V_{CES} | collector-emitter voltage | $T_{vj} = 25\text{ °C}$ | - | 650 | V |
| I_C | collector current | [1] $T_c = 25\text{ °C}$ | - | 80 | A |
| | | $T_c = 100\text{ °C}$ | - | 80 | A |
| I_{CRM} | repetitive peak collector current | [2] | - | 300 | A |
| V_{GE} | gate-emitter voltage | | -20 | 20 | V |
| P_{tot} | total power dissipation | $T_c = 25\text{ °C}$ | - | 502 | W |
| | | $T_c = 100\text{ °C}$ | - | 251 | W |
| T_{vj} | operating junction temperature | | -40 | 175 | °C |
| T_{stg} | storage temperature | | -55 | 150 | °C |
| T_{solder} | soldering temperature | | - | 260 | °C |
| Diode | | | | | |
| I_F | diode forward current | [1] $T_c = 25\text{ °C}$ | - | 80 | A |
| | | $T_c = 100\text{ °C}$ | - | 80 | A |
| I_{FRM} | repetitive peak forward current | [2] | - | 300 | A |

[1] Value is limited by bondwire and $T_{vj(max)}$.

[2] Time duration is limited by $T_{vj(max)}$.

8. Thermal characteristics

Table 5. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------|---|-------------|-----|------|------|------|
| M | mounting torque, M3 screw | | - | 0.6 | - | Nm |
| $R_{th(j-c)}$ | thermal resistance from junction to case | IGBT | - | 0.25 | 0.30 | K/W |
| | | diode | - | 0.38 | 0.47 | K/W |
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | - | - | 40 | K/W |

9. Electrical characteristics

Table 6. Characteristics

All values at $T_{vj} = 25\text{ °C}$, unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------------------------------|--------------------------------------|--|-----|------|------|----------|
| Static characteristics | | | | | | |
| $V_{(BR)CES}$ | collector-emitter breakdown voltage | $V_{GE} = 0\text{ V}; I_C = 0.2\text{ mA}$ | 650 | - | - | V |
| V_{CEsat} | collector-emitter saturation voltage | $V_{GE} = 15\text{ V}; I_C = 75\text{ A}; T_{vj} = 25\text{ °C}$ | - | 1.68 | 2.0 | V |
| | | $V_{GE} = 15\text{ V}; I_C = 75\text{ A}; T_{vj} = 175\text{ °C}$ | - | 2.18 | - | V |
| V_F | diode forward voltage | $V_{GE} = 0\text{ V}; I_F = 75\text{ A}; T_{vj} = 25\text{ °C}$ | - | 1.64 | 1.85 | V |
| | | $V_{GE} = 0\text{ V}; I_F = 75\text{ A}; T_{vj} = 175\text{ °C}$ | - | 1.42 | - | V |
| $V_{GE(th)}$ | gate-emitter threshold voltage | $I_C = 0.75\text{ mA}; V_{CE} = V_{GE}; T_{vj} = 25\text{ °C}$ | 4.3 | 5.0 | 5.7 | V |
| I_{CES} | zero gate voltage collector current | $V_{CE} = 650\text{ V}; V_{GE} = 0\text{ V}; T_{vj} = 25\text{ °C}$ | - | 14 | - | nA |
| | | $V_{CE} = 650\text{ V}; V_{GE} = 0\text{ V}; T_{vj} = 175\text{ °C}$ | - | 0.8 | - | mA |
| I_{GES} | gate-emitter leakage current | $V_{CE} = 0\text{ V}; V_{GE} = 20\text{ V}$ | - | - | 100 | nA |
| g_{fs} | transconductance | $V_{CE} = 20\text{ V}; I_C = 75\text{ A}; T_{vj} = 25\text{ °C}$ | - | 44.4 | - | S |
| r_g | internal gate resistor | | - | 0.7 | - | Ω |
| Dynamic characteristics | | | | | | |
| C_{ies} | input capacitance | $V_{CE} = 25\text{ V}; V_{GE} = 0\text{ V}; f = 1\text{ MHz}$ | - | 3583 | - | pF |
| C_{oes} | output capacitance | | - | 248 | - | pF |
| C_{res} | reverse transfer capacitance | | - | 19 | - | pF |
| Q_G | gate charge | $V_{CC} = 520\text{ V}; V_{GE} = 15\text{ V}; I_C = 75\text{ A}$ | - | 124 | - | nC |
| L_{sCE} | internal stray inductance | measured 5 mm from case | - | 7.9 | - | nH |

650 V, 75 A trench field-stop IGBT with full rated silicon diode

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|---------------------------------------|---|--------------------------------------|-----|------|--------------------|
| IGBT switching characteristics, inductive load | | | | | | |
| $t_{d(on)}$ | turn-on delay time | $V_{GE} = 15/0\text{ V}; V_{CC} = 400\text{ V};$ $I_C = 75\text{ A}; R_{G(on)} = 10\ \Omega;$ $R_{G(off)} = 10\ \Omega;$ see Fig. 27 and Fig. 28 | $T_{vj} = 25\text{ }^\circ\text{C}$ | - | 30 | - ns |
| | | | $T_{vj} = 175\text{ }^\circ\text{C}$ | - | 27 | - ns |
| t_r | rise time | | $T_{vj} = 25\text{ }^\circ\text{C}$ | - | 58 | - ns |
| | | | $T_{vj} = 175\text{ }^\circ\text{C}$ | - | 58 | - ns |
| $t_{d(off)}$ | turn-off delay time | | $T_{vj} = 25\text{ }^\circ\text{C}$ | - | 130 | - ns |
| | | | $T_{vj} = 175\text{ }^\circ\text{C}$ | - | 156 | - ns |
| t_f | fall time | | $T_{vj} = 25\text{ }^\circ\text{C}$ | - | 36 | - ns |
| | | | $T_{vj} = 175\text{ }^\circ\text{C}$ | - | 46 | - ns |
| E_{on} | turn-on switching energy loss | | $T_{vj} = 25\text{ }^\circ\text{C}$ | - | 2.94 | - mJ |
| | | | $T_{vj} = 175\text{ }^\circ\text{C}$ | - | 5.96 | - mJ |
| E_{off} | turn-off switching energy loss | | $T_{vj} = 25\text{ }^\circ\text{C}$ | - | 0.95 | - mJ |
| | | | $T_{vj} = 175\text{ }^\circ\text{C}$ | - | 1.40 | - mJ |
| E_{ts} | total switching energy loss | | $T_{vj} = 25\text{ }^\circ\text{C}$ | - | 3.89 | - mJ |
| | | | $T_{vj} = 175\text{ }^\circ\text{C}$ | - | 7.36 | - mJ |
| Diode switching characteristics, inductive load | | | | | | |
| t_{rr} | reverse recovery time | $V_R = 400\text{ V}; I_F = 75\text{ A};$ $di_F/dt = 500\text{ A}/\mu\text{s};$ see Fig. 26 | $T_{vj} = 25\text{ }^\circ\text{C}$ | - | 122 | - ns |
| | | | $T_{vj} = 175\text{ }^\circ\text{C}$ | - | 251 | - ns |
| Q_{rr} | reverse recovery charge | | $T_{vj} = 25\text{ }^\circ\text{C}$ | - | 1146 | - nC |
| | | | $T_{vj} = 175\text{ }^\circ\text{C}$ | - | 6082 | - nC |
| I_{rrm} | peak reverse recovery current | | $T_{vj} = 25\text{ }^\circ\text{C}$ | - | 21 | - A |
| | | | $T_{vj} = 175\text{ }^\circ\text{C}$ | - | 45 | - A |
| E_{rec} | reverse recovery energy loss | | $T_{vj} = 25\text{ }^\circ\text{C}$ | - | 0.09 | - mJ |
| | | | $T_{vj} = 175\text{ }^\circ\text{C}$ | - | 0.68 | - mJ |
| di_{rrf}/dt | fall rate of reverse recovery current | | $T_{vj} = 25\text{ }^\circ\text{C}$ | - | 294 | - A/ μs |
| | | | $T_{vj} = 175\text{ }^\circ\text{C}$ | - | 282 | - A/ μs |

9.1. Characteristic diagrams

Table 7. Waveforms and output characteristics

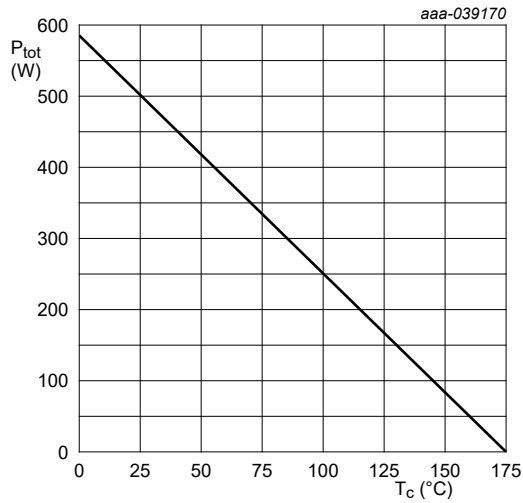


Fig. 1. Power dissipation as a function of case temperature

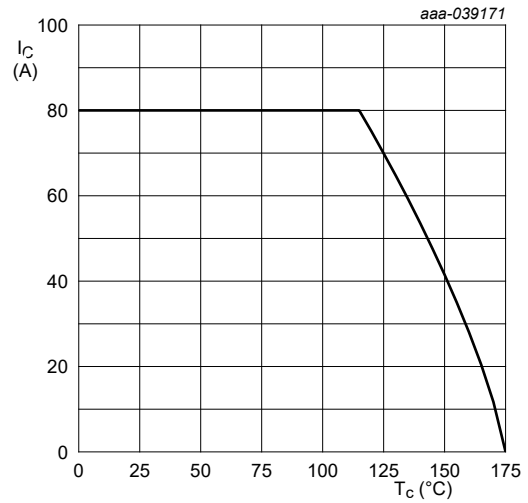
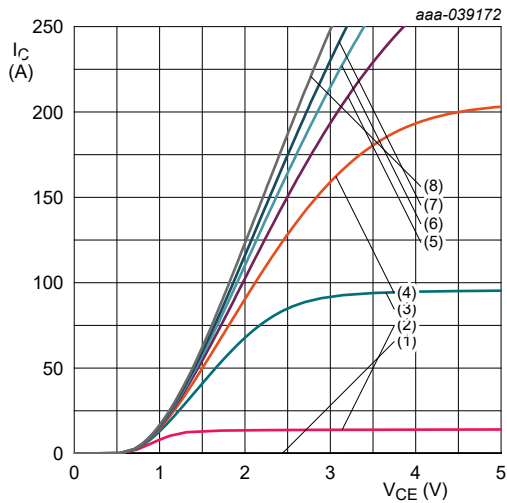
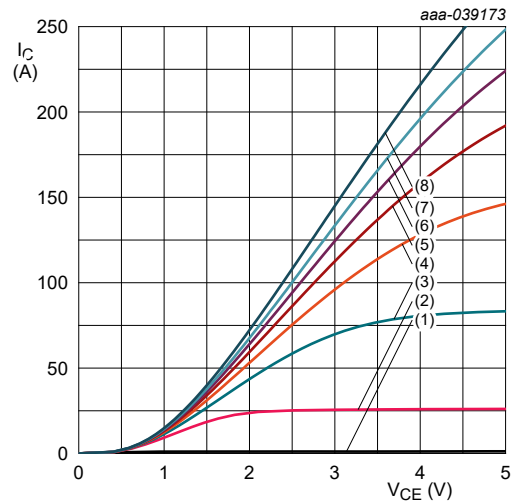


Fig. 2. Collector current as a function of case temperature



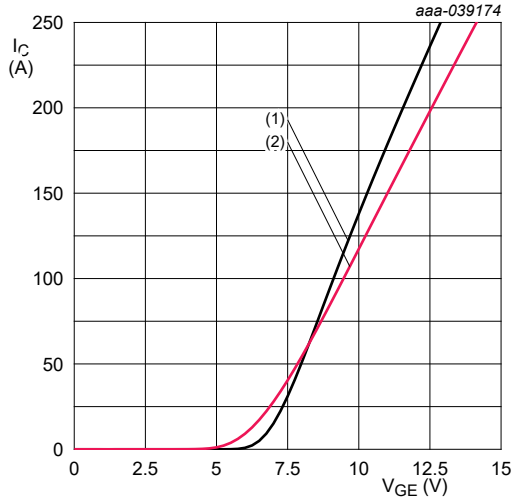
- $T_{vj} = 25\text{ °C}$
- (1) $V_{GE} = 5\text{ V}$
 - (2) $V_{GE} = 7\text{ V}$
 - (3) $V_{GE} = 9\text{ V}$
 - (4) $V_{GE} = 11\text{ V}$
 - (5) $V_{GE} = 13\text{ V}$
 - (6) $V_{GE} = 15\text{ V}$
 - (7) $V_{GE} = 17\text{ V}$
 - (8) $V_{GE} = 20\text{ V}$

Fig. 3. Collector current as a function of collector-emitter voltage



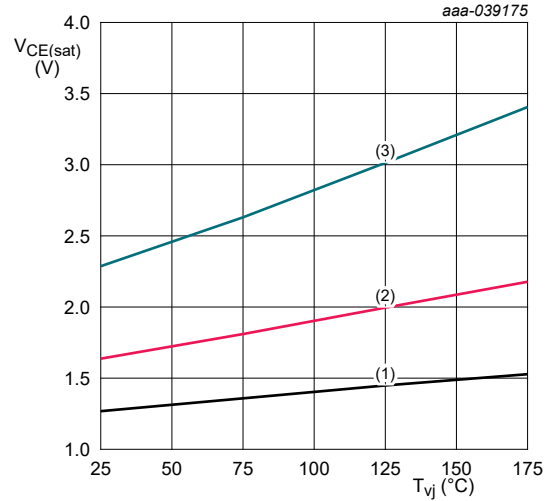
- $T_{vj} = 175\text{ °C}$
- (1) $V_{GE} = 5\text{ V}$
 - (2) $V_{GE} = 7\text{ V}$
 - (3) $V_{GE} = 9\text{ V}$
 - (4) $V_{GE} = 11\text{ V}$
 - (5) $V_{GE} = 13\text{ V}$
 - (6) $V_{GE} = 15\text{ V}$
 - (7) $V_{GE} = 17\text{ V}$
 - (8) $V_{GE} = 20\text{ V}$

Fig. 4. Collector current as a function of collector-emitter voltage



$V_{CE} = 20$ V
 (1) $T_{vj} = 25$ °C
 (2) $T_{vj} = 175$ °C

Fig. 5. Collector current as a function of gate-emitter voltage



$V_{GE} = 15$ V
 (1) $I_C = 37.5$ A
 (2) $I_C = 75$ A
 (3) $I_C = 150$ A

Fig. 6. Collector-emitter saturation voltage as a function of junction temperature

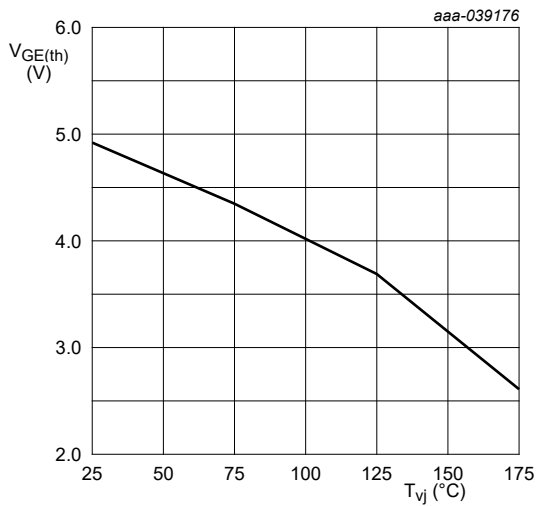
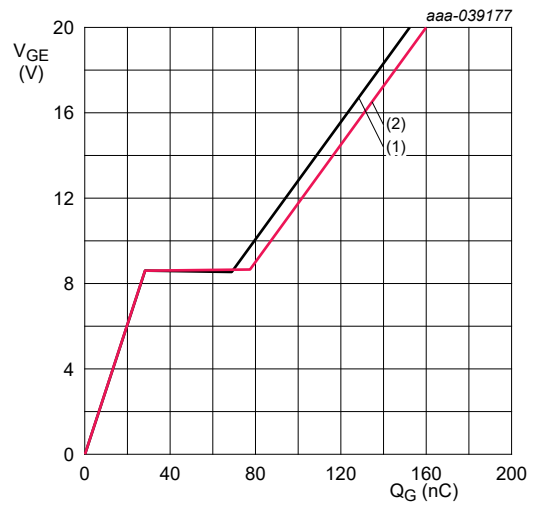
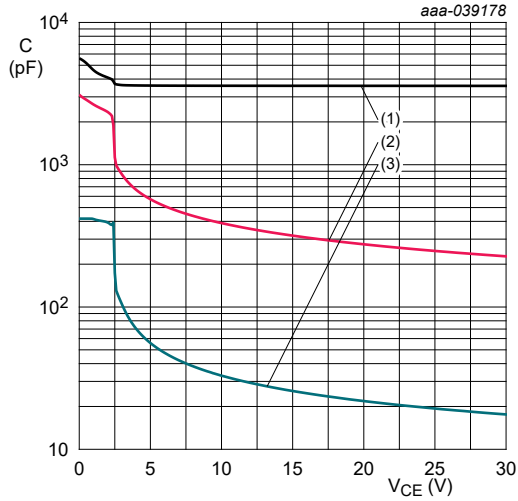


Fig. 7. Gate-emitter threshold voltage as a function of junction temperature



$I_C = 75$ A
 (1) $V_{CE} = 130$ V
 (2) $V_{CE} = 520$ V

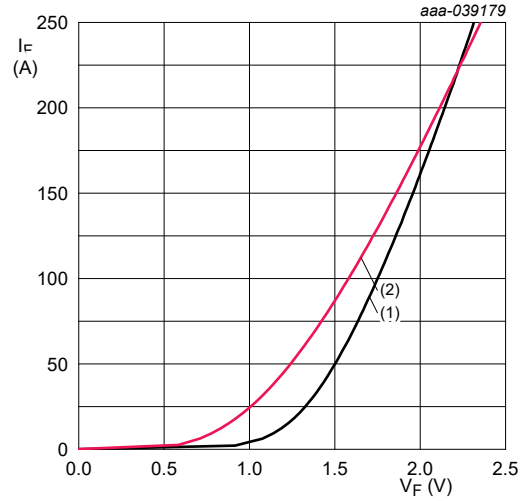
Fig. 8. Gate-emitter voltage as a function of gate charge



$V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$

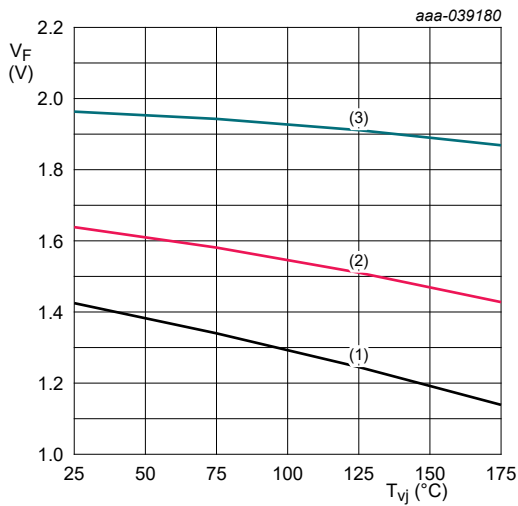
- (1) C_{ies}
- (2) C_{oes}
- (3) C_{res}

Fig. 9. Typical capacitance as a function of collector-emitter voltage



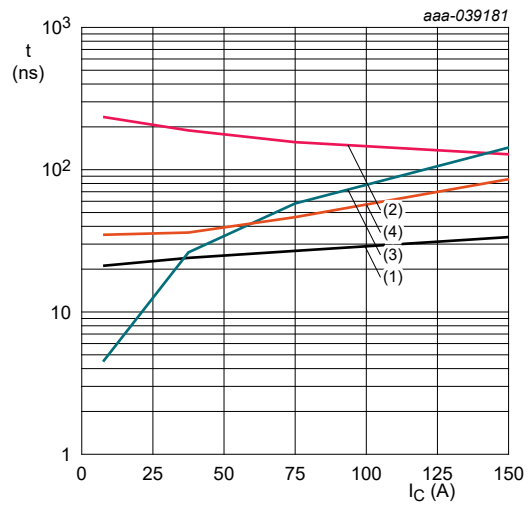
- (1) $T_{vj} = 25 \text{ }^\circ\text{C}$
- (2) $T_{vj} = 175 \text{ }^\circ\text{C}$

Fig. 10. Typical diode forward current as a function of forward voltage



- (1) $I_F = 37.5 \text{ A}$
- (2) $I_F = 75 \text{ A}$
- (3) $I_F = 150 \text{ A}$

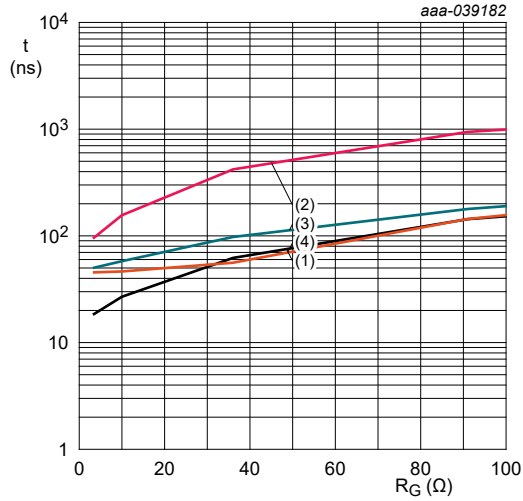
Fig. 11. Typical diode forward voltage as a function of junction temperature



$V_{GE} = 15 \text{ V to } 0 \text{ V}; V_{CC} = 400 \text{ V}; R_{G(on)} = 10 \text{ } \Omega;$
 $R_{G(off)} = 10 \text{ } \Omega; T_{vj} = 175 \text{ }^\circ\text{C}$

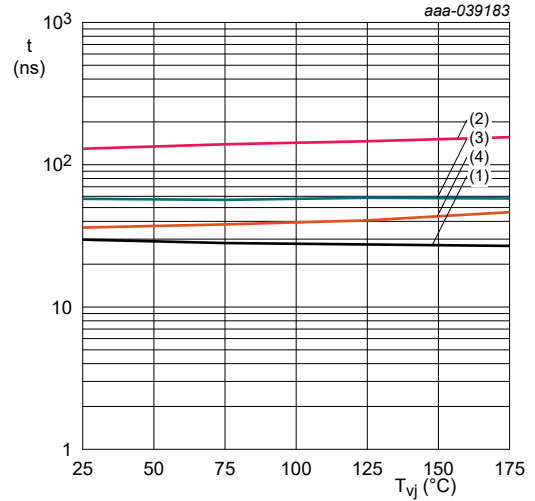
- (1) $t_{d(on)}$
- (2) $t_{d(off)}$
- (3) t_r
- (4) t_f

Fig. 12. Typical switching times as a function of collector current



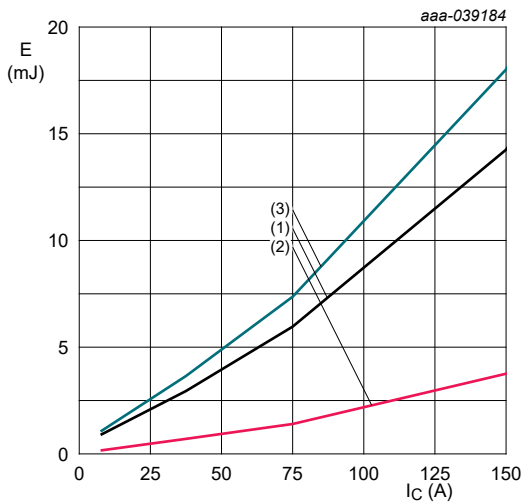
$V_{GE} = 15\text{ V to }0\text{ V}; V_{CC} = 400\text{ V}; I_C = 75\text{ A};$
 $T_{vj} = 175\text{ }^\circ\text{C}$
 (1) $t_{d(on)}$
 (2) $t_{d(off)}$
 (3) t_r
 (4) t_f

Fig. 13. Typical switching times as a function of gate resistance



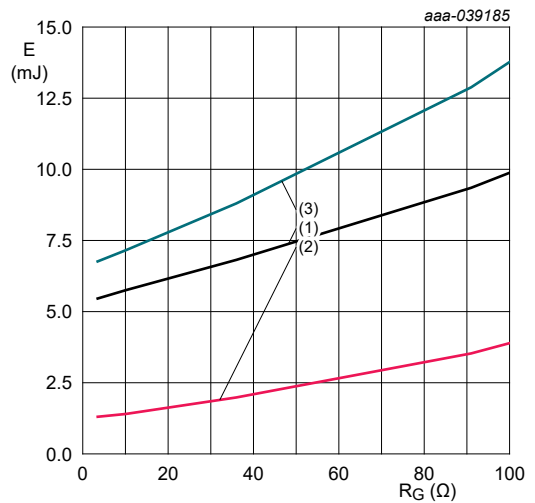
$V_{GE} = 15\text{ V to }0\text{ V}; I_C = 75\text{ A}; V_{CC} = 400\text{ V};$
 $R_{G(on)} = 10\text{ }^\Omega; R_{G(off)} = 10\text{ }^\Omega$
 (1) $t_{d(on)}$
 (2) $t_{d(off)}$
 (3) t_r
 (4) t_f

Fig. 14. Typical switching times as a function of junction temperature



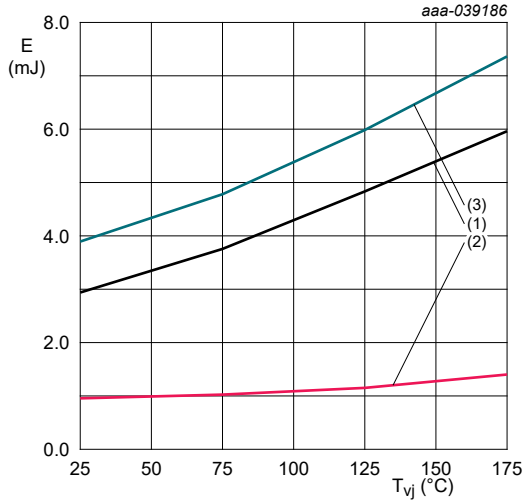
$V_{GE} = 15\text{ V to }0\text{ V}; V_{CC} = 400\text{ V}; R_{G(on)} = 10\text{ }^\Omega;$
 $R_{G(off)} = 10\text{ }^\Omega; T_{vj} = 175\text{ }^\circ\text{C}$
 (1) E_{on}
 (2) E_{off}
 (3) E_{ts}

Fig. 15. Typical switching energy losses as a function of collector current



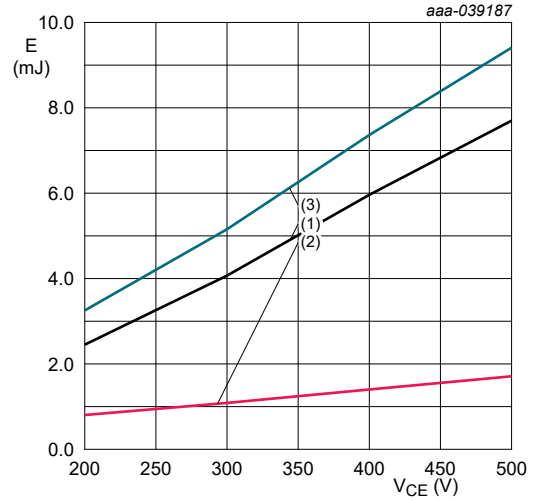
$V_{GE} = 15\text{ V to }0\text{ V}; V_{CC} = 400\text{ V}; I_C = 75\text{ A};$
 $T_{vj} = 175\text{ }^\circ\text{C}$
 (1) E_{on}
 (2) E_{off}
 (3) E_{ts}

Fig. 16. Typical switching energy losses as a function of gate resistance



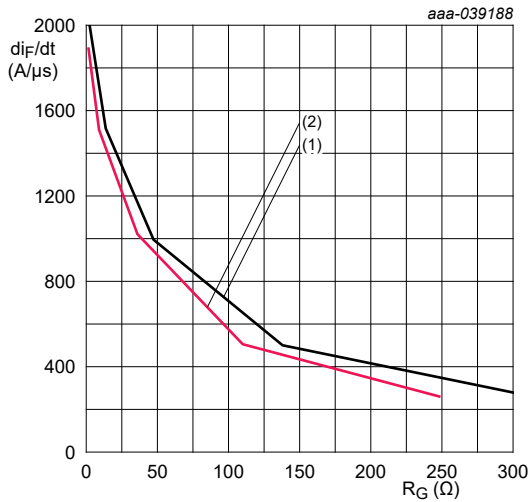
$V_{GE} = 15\text{ V to }0\text{ V}; I_C = 75\text{ A}; V_{CC} = 400\text{ V};$
 $R_{G(on)} = 10\ \Omega; R_{G(off)} = 10\ \Omega$
 (1) E_{on}
 (2) E_{off}
 (3) E_{ts}

Fig. 17. Typical switching energy losses as a function of junction temperature



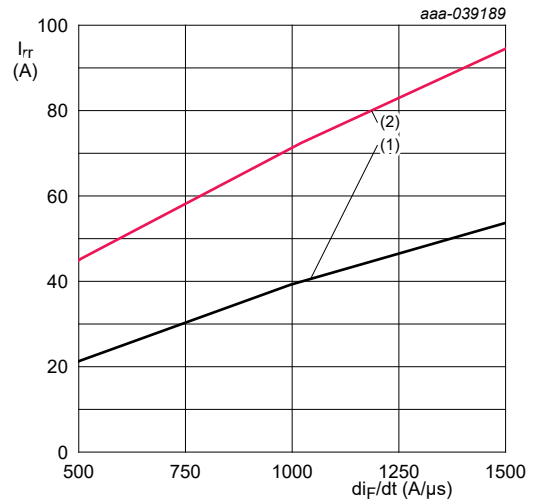
$V_{GE} = 15\text{ V to }0\text{ V}; I_C = 75\text{ A}; R_{G(on)} = 10\ \Omega;$
 $R_{G(off)} = 10\ \Omega; T_{vj} = 175\text{ }^\circ\text{C}$
 (1) E_{on}
 (2) E_{off}
 (3) E_{ts}

Fig. 18. Typical switching energy losses as a function of collector-emitter voltage



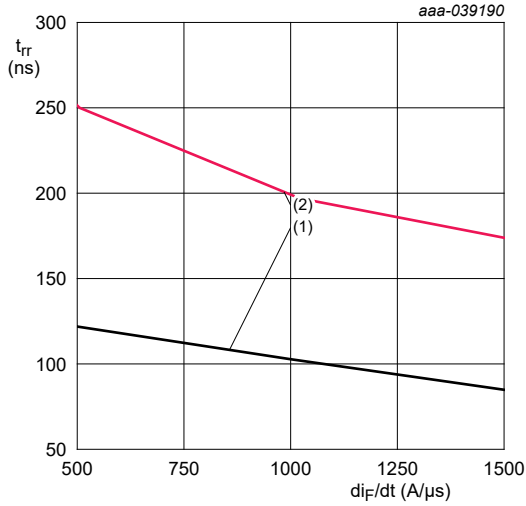
$V_R = 400\text{ V}; I_F = 75\text{ A}$
 (1) $T_{vj} = 25\text{ }^\circ\text{C}$
 (2) $T_{vj} = 175\text{ }^\circ\text{C}$

Fig. 19. Typical rate of change of forward current as a function of change of gate resistance



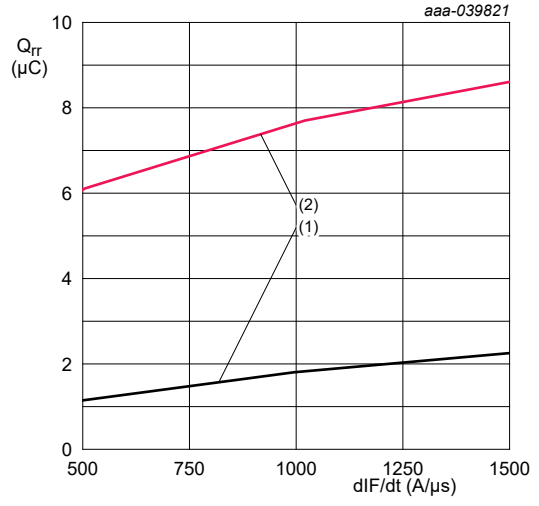
$V_R = 400\text{ V}; I_F = 75\text{ A}$
 (1) $T_{vj} = 25\text{ }^\circ\text{C}$
 (2) $T_{vj} = 175\text{ }^\circ\text{C}$

Fig. 20. Typical reverse recovery current as a function of rate of change of forward current



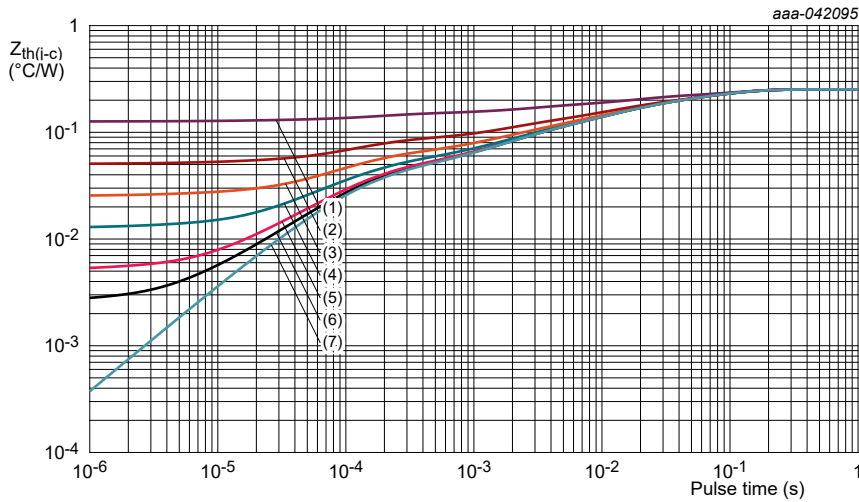
$V_R = 400 \text{ V}; I_F = 75 \text{ A}$
 (1) $T_{vj} = 25 \text{ }^\circ\text{C}$
 (2) $T_{vj} = 175 \text{ }^\circ\text{C}$

Fig. 21. Typical reverse recovery time as a function of rate of change of forward current



$V_R = 400 \text{ V}; I_F = 75 \text{ A}$
 (1) $T_{vj} = 25 \text{ }^\circ\text{C}$
 (2) $T_{vj} = 175 \text{ }^\circ\text{C}$

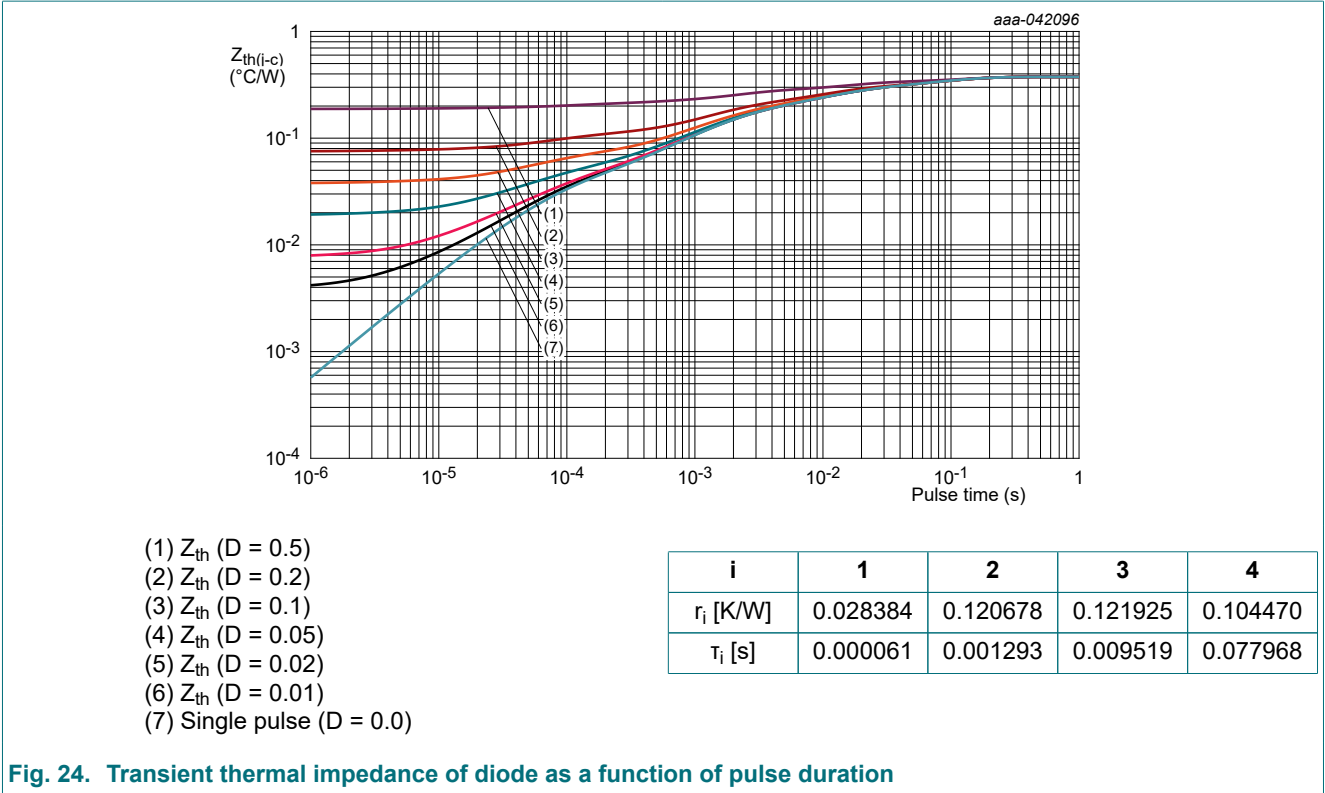
Fig. 22. Typical reverse recovery charge as a function of rate of change of forward current



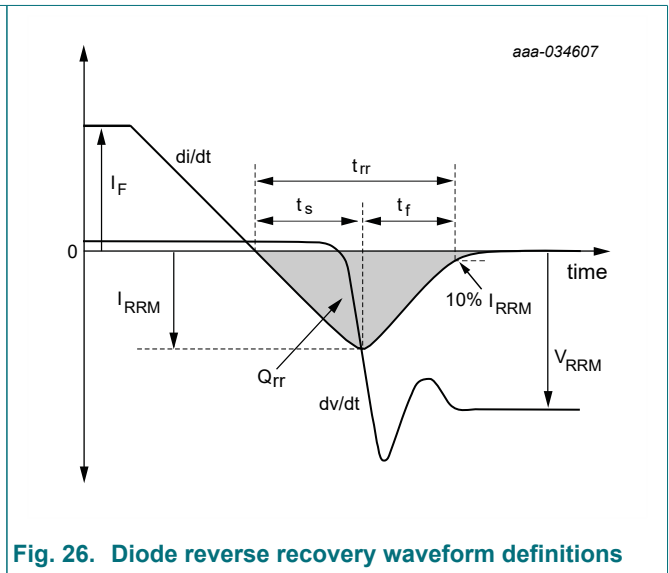
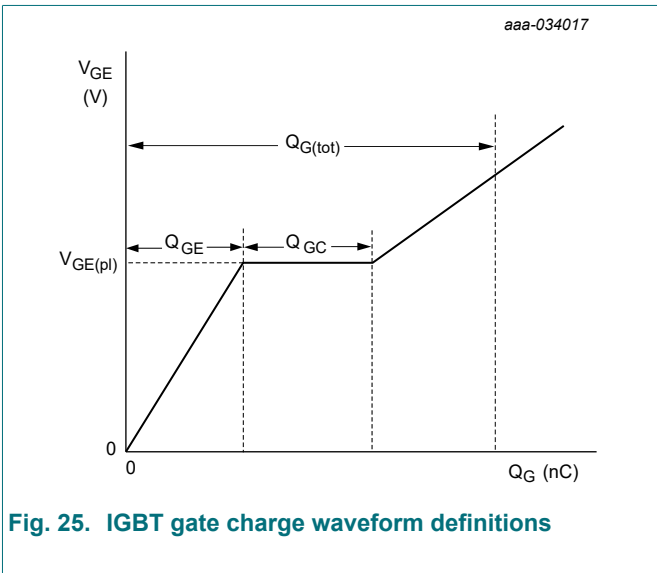
- (1) $Z_{th} (D = 0.5)$
- (2) $Z_{th} (D = 0.2)$
- (3) $Z_{th} (D = 0.1)$
- (4) $Z_{th} (D = 0.05)$
- (5) $Z_{th} (D = 0.02)$
- (6) $Z_{th} (D = 0.01)$
- (7) Single pulse ($D = 0.0$)

| i | 1 | 2 | 3 | 4 |
|--------------|----------|----------|----------|----------|
| r_i [K/W] | 0.037322 | 0.043607 | 0.076702 | 0.095035 |
| τ_i [s] | 0.000109 | 0.001718 | 0.011075 | 0.066734 |

Fig. 23. Transient thermal impedance of IGBT as a function of pulse duration



9.2. Waveform definitions



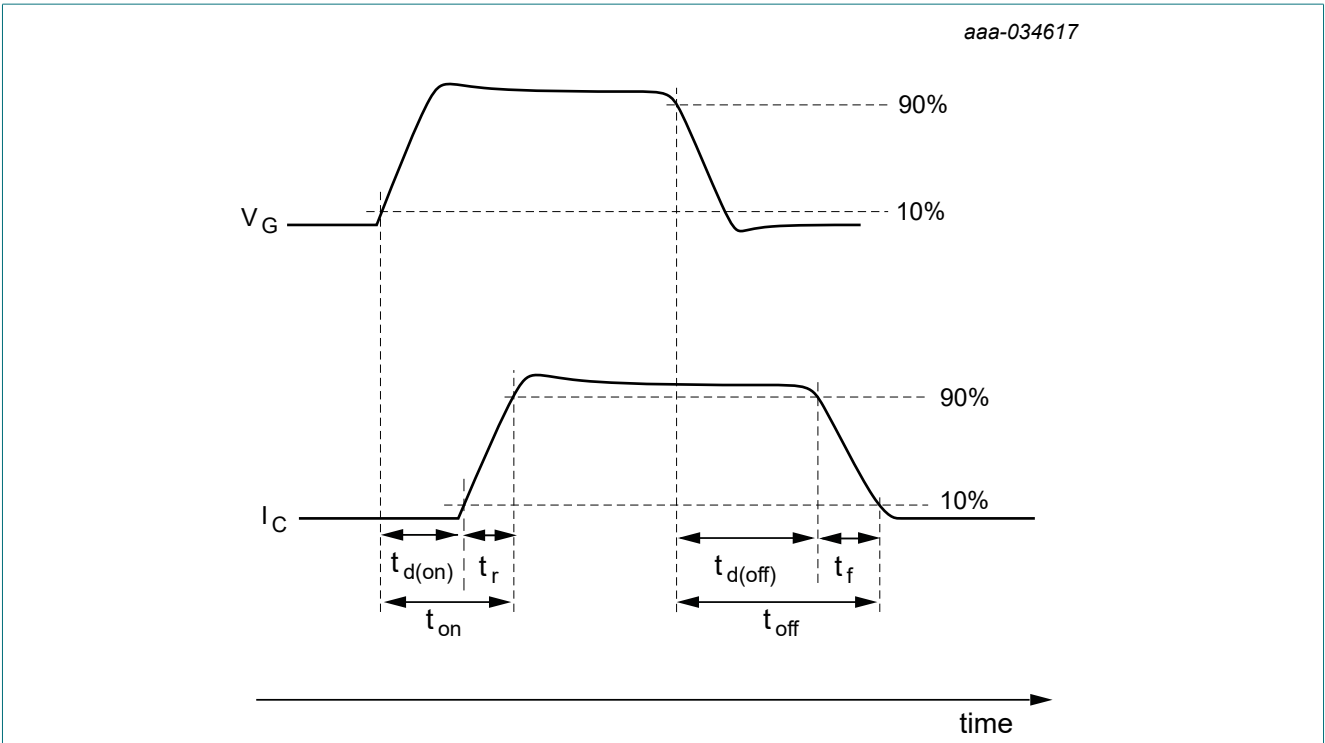


Fig. 27. IGBT switching times definitions

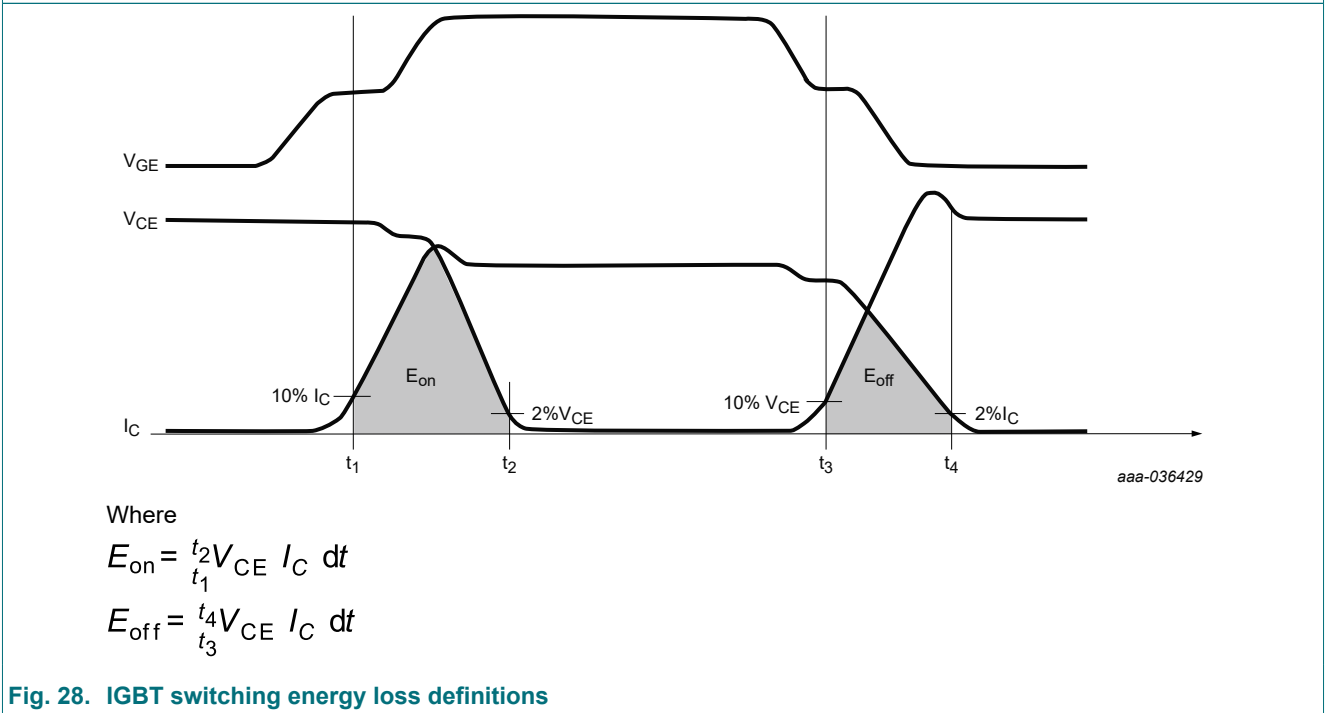


Fig. 28. IGBT switching energy loss definitions

10. Package outline

Plastic single-ended through-hole package; heatsink mounted; 1 mounting hole; 3-lead TO-247-3L

SOT429-2

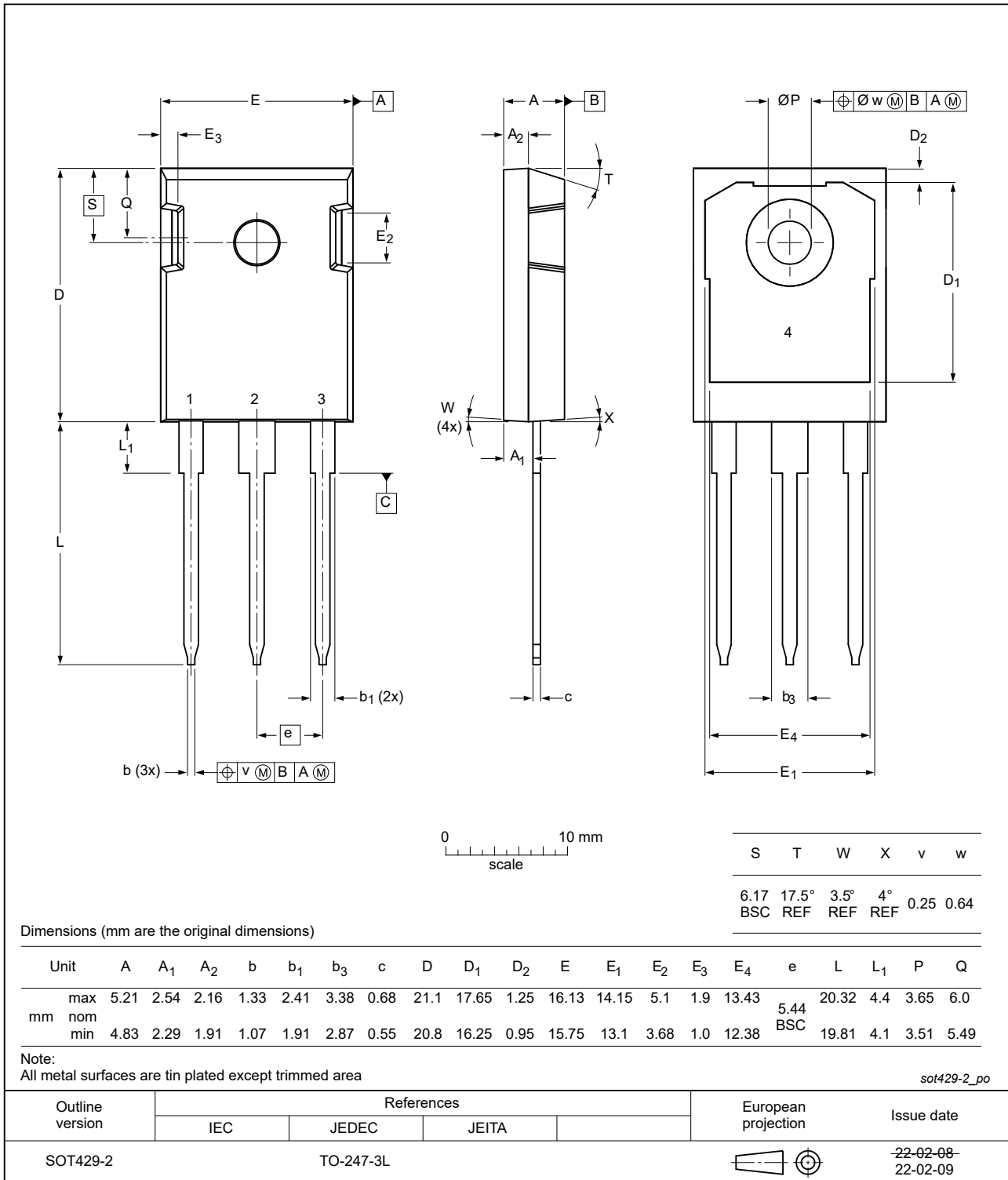


Fig. 29. Package outline TO-247-3L (SOT429-2)

11. Revision history

Table 8. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|--------------------|--------------|--------------------|---------------|------------|
| NGW75T65H3DFP v. 1 | 20250117 | Product data sheet | - | - |

12. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|--------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <https://www.nexperia.com>.

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